

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: LEE, Hung-Wen et al. Conf.:
Appl. No.: NEW Group:
Filed: June 23, 2003 Examiner:
For: WAFER SHIPPING DEVICE AND STORAGE
METHOD FOR PREVENTING FLUORIDATION IN
BONDING PADS

L E T T E R

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

June 23, 2003

Sir:

Under the provisions of 35 U.S.C. § 119 and 37 C.F.R. § 1.55(a), the applicant(s) hereby claim(s) the right of priority based on the following application(s):

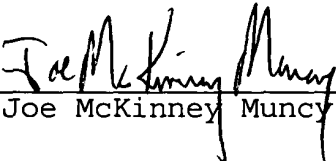
| <u>Country</u> | <u>Application No.</u> | <u>Filed</u> |
|----------------|------------------------|---------------|
| TAIWAN, R.O.C. | 091113771 | June 24, 2002 |

A certified copy of the above-noted application(s) is(are) attached hereto.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fee required under 37 C.F.R. §§ 1.16 or 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By 
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Attachment(s)